

1752-2 1.1

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This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.

ICP Web Site for information on IPC-1752 Standard http://www.ipc.org/IPC-175x

Declaration Class\* Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Form Type\* Distribute Infomation

Supplier Information					
Company Name *	Company Unique ID	Unique ID Authority	Response Date*		
Fairchild Semiconductor	00-489-5751	Dun & Bradstreet	Sat, Aug 09, 2014 02:14 AM		
Contact Name *	Title - Contact	Phone - Contact *	Email - Contact *		
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Authorized Representative *	Title - Representative	Phone - Representative *	Email - Representative *		
David Lancaster	Product Ecology	801-562-7455	david.lancaster@fairchildsemi.com		

Requester Item Number	Mfr Item Number		Mfr Item Name Effective Date		Version	Manufacturing Site		ing Site Weight*		Unit Type	
FAN2106MPX	FAN2106MF	PX 25-M	LP 5X6 (BWAu&Cu) (G)			INTERNAL PENANG		0.068800	g	Each	
Manufacturing Process Information											
Terminal Finis	sh	Base Alloy	J-STD-020 MSL Rat	ing Peak	Process Body	Temperature	ture Max Time at Peak Temperature		re No	No Reflow cycles	
Nickel/Palladium/Gold (Ni/Pd/Au)		CU Alloy	1		260 C		30 seconds			3	

\* Required Field

 RoHS Material Composition Declaration
 Declaration Type \* Custom

 RoHS Directive 2011/65/EU
 RoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Diphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Diphenyl Ethers (PBDE)

This document is Fairchild Semiconductor's statement regarding the directive 2011/65/EU of the European Parliament and of the council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS Recast). The content of this document is based upon information collected from Fairchild Semiconductor supply chain, manufacturing facilities and affiliates worldwide.

The FSC part number listed above and the homogenous materials in the product are compliant with the Directive 2011/65/EU. Fairchild has implemented systems to ensure our products are compliant to environmental regulations and laws worldwide. However, not all materials in Fairchild's products may have been independently verified regarding substance content. In the event of any issues arising from information in this document, the warranty section of Fairchild's standard terms and conditions of sale shall apply, unless alternate contracts have been agreed upon in writing by both parties.

Note: The substance content disclosed herewith is approximate and is based on various methods including, engineering calculations, supplier surveys, Material Safety Data Sheets, analytical measurements. Fairchild may update this document without notification. This statement may not include information regarding the miniscule quantities of dopant and metal materials in the electrical devices contained within the finished product. CAS numbers listed for Resin substances are generic and may contain alternate substances of similar composition.

RoHS Declaration \* 1 - Item

1 - Item(s) does not contain RoHS restricted substances per the definition above Supplier Acceptance \* Accepted

Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions. Exemption List Version EL-2011/534/EU

**Declaration Signature** 

and Loncosto

Supplier Signature

DAVID LANCASTER - PRODUCT ECOLOGY MANAGER

## Homogeneous Material Composition Declaration for Electronic Products

Item/SubItem Name 25-MLP 5X6 (BWAu&Cu) (G)

Component	Material	Weight (mg)	Jig Level	Substance Category	Substance	Weight (mg)	CAS	PPM
Chip	Other inorganic materials	2.740	Supplier		Silicon	2.740	7440-21-3	39826
Die Attach	Other Organic Materials	0.518	Supplier		Phenolic resin	0.026	54208-63-8	376
			Supplier		Silver	0.492	7440-22-4	7151
Encapsulation	Thermoplastics	40.900	Supplier		Carbon Black	0.409	1333-86-4	5945
			Supplier		Epoxy Resin	8.180	29690-82-2	118895
			Supplier		Silica, vitreous	32.311	60676-86-0	469637
Lead Frame	Copper & its alloys	23.905	Supplier		Copper	23.200	7440-50-8	337209
			Supplier		Iron	0.621	7439-89-6	9026
			Supplier		Phosphorus	0.036	7723-14-0	522
			Supplier		Zinc	0.048	7440-66-6	695
Terminal Finish	Precious metals	0.233	Supplier		Gold	0.003	7440-57-5	51
			В	Nickel (external applications only)	Nickel	0.209	7440-02-0	3031
			Supplier		Palladium	0.021	7440-05-3	305
Wire Bond - Au	Precious metals	0.296	Supplier		Gold	0.296	7440-57-5	4302
Wire Bond - Cu	Copper & its alloys	0.253	Supplier		Copper	0.253	7440-50-8	3677